

**Assembly Transfer to ASE Korea and Test site to STATS ChipPAC Singapore
of Select LFCSP Parts**

**Qualification Results Summary
for LFCSP at ASE Korea**

QUALIFICATION RESULT			
TEST	SPECIFICATION	SAMPLE SIZE	RESULT
Temperature Cycle (TC)*	JEDEC <i>JESD22-A104</i>	3 x 77	PASS
Highly Accelerated Stress Test (HAST)*	JEDEC <i>JESD22-A110</i>	3 x 77	PASS
Autoclave (AC)*	JEDEC <i>JESD22-A102</i>	3 x 77	PASS
Solder Heat Resistance (SHR)*	JEDEC/IPC <i>J-STD-020</i>	3 x 11	PASS
High Temperature Storage (HTS)	JEDEC <i>JESD22-A103</i>	3 x 77	PASS

*Preconditioned per JEDEC/IPC J-STD-020